

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHIA-LING HSU	03/28/2011
RECEIVING PARTY DATA	
Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	66,CHUNG SHAN ROAD
City:	Tu-Cheng, New Taipei
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13077916
CORRESPONDENCE DATA	
Fax Number:	(909)978-6366
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	9099786584
Email:	Raymond.Chew@foxconn.com
Correspondent Name:	Raymond J. Chew
Address Line 1:	288 South Mayo Avenue
Address Line 4:	City of Industry, CALIFORNIA 91789
ATTORNEY DOCKET NUMBER:	US38506
NAME OF SUBMITTER:	Raymond J. Chew
Total Attachments: 2 source=US38506110330ASM#page1.tif source=US38506110330ASM#page2.tif	

CH \$40.00 13077916

501487758

PATENT
REEL: 026058 FRAME: 0807

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. CHIA-LING HSU , residing at Tu-Cheng, New Taipei, Taiwan
2. _____ , residing at _____
3. _____ , residing at _____
4. _____ , residing at _____
5. _____ , residing at _____
6. _____ , residing at _____
7. _____ , residing at _____
8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **INJECTION MOLDING METHOD** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1. Chia-Ling Hsu Mar. 28, 2011
CHIA-LING HSU Date

2. _____
Date

3. _____
Date

4. _____
Date

5. _____
Date

6. _____
Date

7. _____
Date

8. _____
Date

9. _____
Date